



DMG7401SFGQ

P-CHANNEL ENHANCEMENT MODE MOSFET POWERDI[®]

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
-30V	13mΩ @ V _{GS} = -10V	-9.8A
	25mΩ @ V _{GS} = -4.5V	-7.0A

Description

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

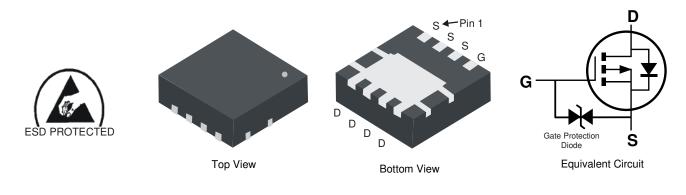
Features and Benefits

- Low R_{DS(ON)} Ensures On-State Losses Are Minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: POWERDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0174 grams (Approximate)

POWERDI3333-8



Ordering Information (Note 5)

Part Number	Case	Packaging
DMG7401SFGQ-7	POWERDI3333-8	2,000/Tape & Reel
DMG7401SFGQ-13	POWERDI3333-8	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



G75 = Product Marking Code $\begin{array}{l} YYWW = \text{Date Code Marking} \\ YY = \text{Last Digit of Year (ex: 10 for 2010)} \\ WW = \text{Week Code (01 - 53)} \end{array}$

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Drain Current (Note 7) V _{GS} = -10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	Ι _D	-9.8 -7.7	A
	t<10s	T _A = +25°C T _A = +70°C	I _D	-13.5 -10.8	А
Maximum Continuous Body Diode Forward Current (Note 6)			ls	-3.0	A
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-80	A
Avalanche Current (Notes 8 & 9)			I _{AR}	14	A
Repetitive Avalanche Energy (Notes 8 & 9) L = 1mH			E _{AR}	104	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	D-	0.94	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD	0.6	vv	
Thermal Registeres, Junction to Ambient (Note 6)	Steady State	D	137	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R _{θJA}	82	°C/W	
Total Dower Dissinction (Note 7)	T _A = +25°C	P	2.2	W	
Total Power Dissipation (Note 7)	T _A = +70°C	PD	1.3	vv	
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	D	60	°C/W	
memai Resistance, Junction to Ambient (Note 7)	t<10s	R _{θJA}	36	°C/W	
Thermal Resistance, Junction to Case (Note 7)	R _{ejc}	3.0	°C/W		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate. Notes:

8. I_{AB} and E_{AB} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.



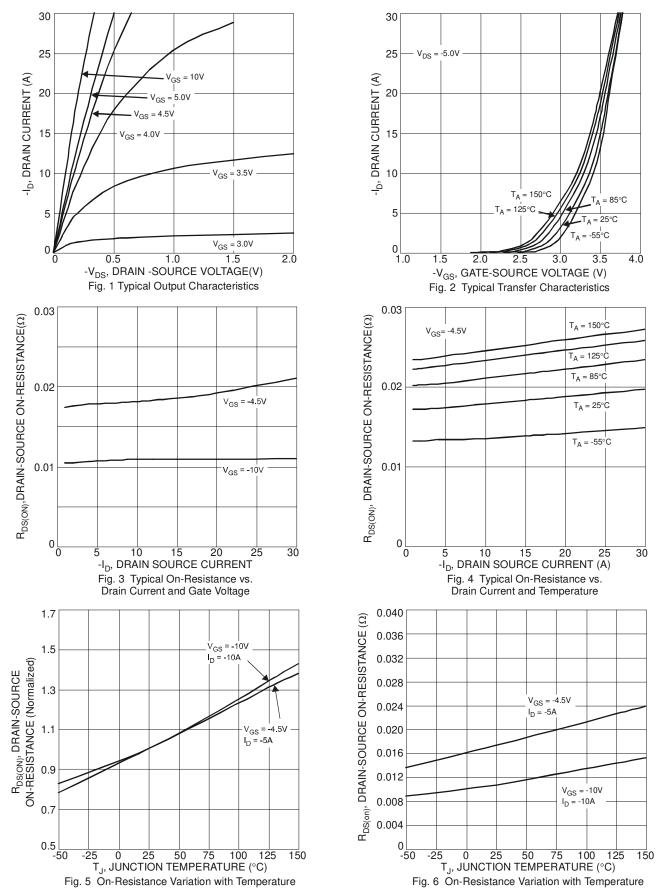
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	—		V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		—	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)						-	
Gate Threshold Voltage	V _{GS(th)}	-1.7	_	-3.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
		_	9	11	mΩ	$V_{GS} = -20V, I_D = -12A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	10	13		$V_{GS} = -10V, I_D = -9A$	
		_	17	25		$V_{GS} = -4.5V, I_D = -5A$	
Forward Transfer Admittance	Y _{fs}		21	_	S	V _{DS} = -5V, I _D = -10A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}	_	2,246	2,987	рF		
Output Capacitance	Coss	_	352	468	pF	− V _{DS} = -15V, V _{GS} = 0V, − f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		294	391	pF		
Gate resistance	Rg	_	5.1	10	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	20.5	30	nC		
Total Gate Charge (V _{GS} = 10V)	Qg		41	58	nC		
Gate-Source Charge	Q _{gs}	_	7.6	_	nC	$V_{DS} = -15V, I_D = -12A$	
Gate-Drain Charge	Q _{gd}		8.0	—	nC	7	
Turn-On Delay Time	t _{D(on)}	_	11.3	23	nS		
Turn-On Rise Time	tr	_	15.4	31	nS	$V_{DD} = -15V, V_{GS} = -10V,$	
Turn-Off Delay Time	t _{D(off)}		38.0	61	nS	$R_L = 1.25\Omega, R_G = 3\Omega,$	
Turn-Off Fall Time	tf	_	22.0	38	nS	7	
BODY DIODE CHARACTERISTICS	•				•	·	
Diode Forward Voltage	V _{SD}		-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
Reverse Recovery Time (Note 10)	t _{rr}		20	31	nS		
Reverse Recovery Charge (Note 10)	Q _{rr}	_	9.5	18	nC	I _S = -9.5A, dl/dt = 100A/μs	

Notes:9. Short duration pulse test used to minimize self-heating effect.10. Guaranteed by design. Not subject to product testing.

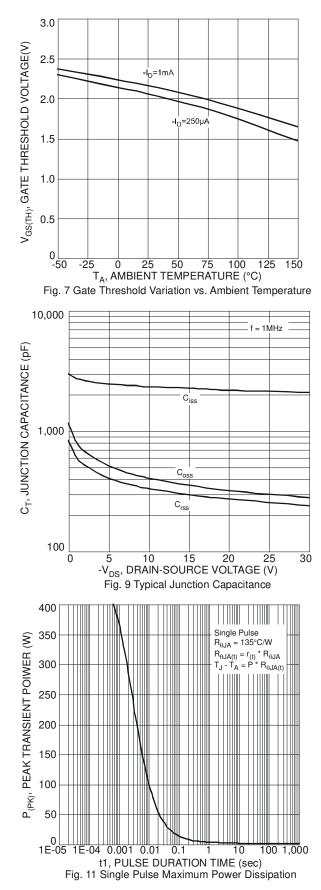


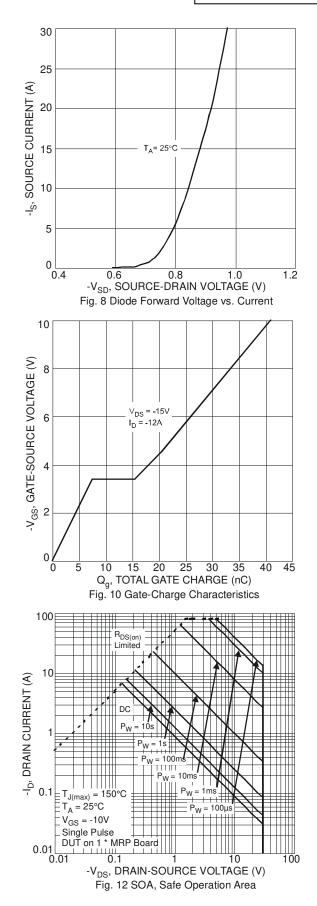
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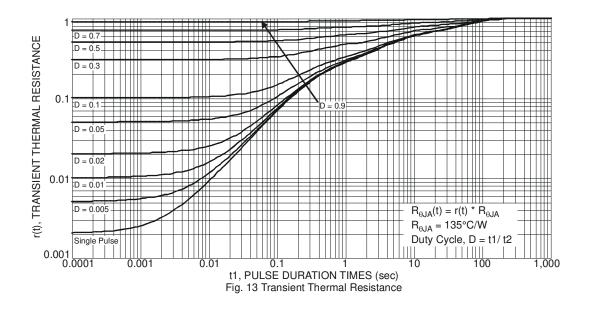


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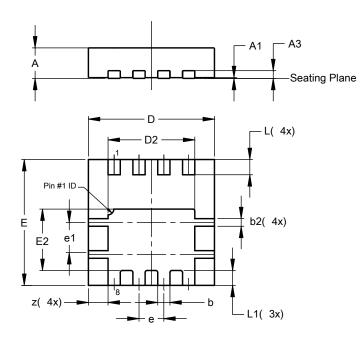






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

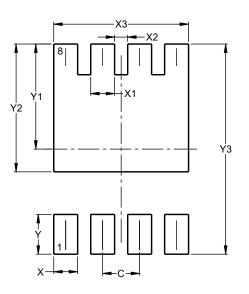


POWERDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	-	-	0.203		
b	0.27	0.37	0.32		
b2	_	_	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
е	-	-	0.65		
e1	0.79	0.89	0.84		
L	0.35	0.45	0.40		
L1	_	-	0.39		
z	_	-	0.515		
	All Dimensions in mm				

POWERDI3333-8

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



POWERDI3333-8

Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
X3	2.370		
Y	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		



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